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<th>ALL ARTWORK VIEWED FROM TOP SIDE</th>
<th>BOARD #</th>
<th>TIDA-00242</th>
<th>REV#</th>
<th>SUN REV# Not In VersionControl</th>
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All artwork viewed from top side

Layer name = M2 Board Dimensions

Plot name = Board Dimensions

Board #: TIDA-00242 SOL REV: SUN REV: Not In Version Control


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<tr>
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